

	SS-QFE128SD-01 Drawing	Status: Released	Scale: N/A Rev: A		Rev: A
	© 2009 IRONWOOD ELECTRONICS, INC. 11351 Rupp Drive, Suite 400, Burnsville, MN 55337 Tele: (952) 229-8200 www.ironwoodelectronics.com	Drawing: M.A. Fedde		Date: 4/17/09	
		File: SS-QFE128SD-01 Dwg Modified:			

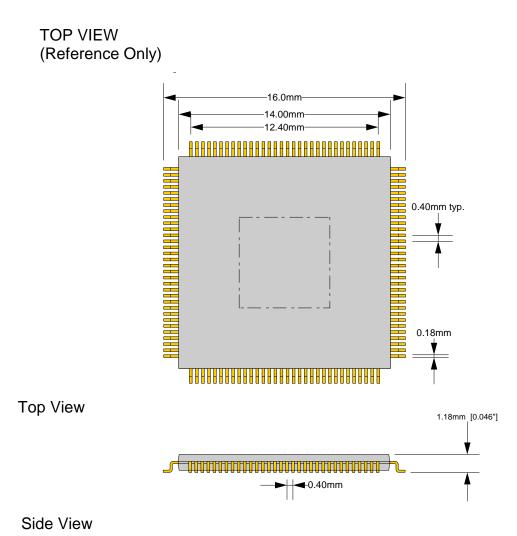
otherwise). Materials and specifications are subject to change without notice.

## Recommended PCB Layout Top View **Orientation Mark** -1.25mm±0.13mm(x4) -6.66mm 5.24mm -0.40mm typ. 1.25mm±0.13mm(x4) Socket 2.540mm **Body Size** 5.24mm 6.66mm Ø 0.850mm±0.025mm (x2) 49.23mm [1.938"] Alignment Hole Socket **Body Size** -1.78 x 0.23mm pad 5.080mm \_9mm GND pad 12.40mm Ø 1.75mm±0.05mm (x4) 15.24mm Mounting Hole -25.725mm(x4) -28.225mm±0.125mm (x4) **DXF DATA WILL BE PROVIDED** -42.60mm socket lid siz [1.677"]

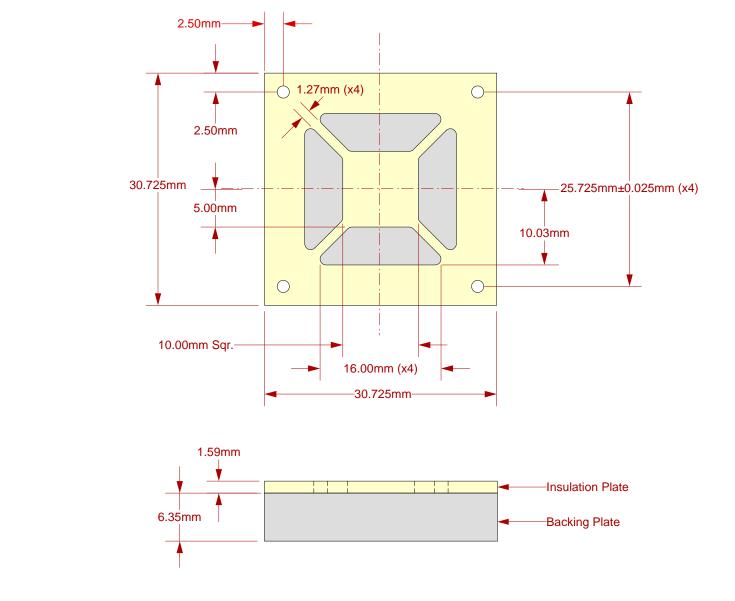
Target PCB Recommendations
Total thickness: 1.5mm min,
3mm without a backing plate
Plating: Gold or Solder finish

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Recommended PCB Layout Tolerances: ±0.025mm [±0.001"] unless stated otherwise.



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Description: Backing Plate with Insulation Plate

Top View

Side View

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